

	Type	Hits	Search Text
1	IS&R	2	("20010002734").PN.
2	IS&R	18	((("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699"))).PN. or (2001/0002726).CCLS.
3	BRS	162	(copper cu al aluminum) near3 (pad) with (gold au) near2 (coat\$3 film)
4	BRS	80	((copper cu al aluminum) near3 (pad) with (gold au) near2 (coat\$3 film)) and solder\$3 and wir\$3
5	IS&R	3	("5909633").PN.
6	BRS	2	jp-11067957-\$.did.
7	IS&R	18	((("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699"))).PN. or (2001/0002726).CCLS.
8	BRS	9	(US-4788767-\$ or US-6169330-\$ or US-5311404-\$ or US-5380679-\$ or US-5663598-\$ or US-5909633-\$).did. or (US-20030102548-\$).did. or (JP-10163241-\$ or JP-11067957-\$).did.
9	BRS	23	((("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699"))).PN. or (2001/0002726).CCLS.) ((US-4788767-\$ or US-6169330-\$ or US-5311404-\$ or US-5380679-\$ or US-5663598-\$ or US-5909633-\$).did. or (US-20030102548-\$).did. or (JP-10163241-\$ or JP-11067957-\$).did.)
10	BRS	557	bond near pad with ((copper cu) and (al aluminum))

	DBs
1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
8	US-PGPUB; USPAT; DERWENT
9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text
11	BRS	1	((("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699")).PN. or (2001/0002726).CCLS.) ((US-4788767-\$ or US-6169330-\$ or US-5311404-\$ or US-5380679-\$ or US-5663598-\$ or US-5909633-\$).did. or (US-20030102548-\$).did. or (JP-10163241-\$ or JP-11067957-\$).did.)) and (bond near pad with ((copper cu) and (al aluminum)))
12	BRS	435	bond near pad with ((copper cu) with (al aluminum))
13	IS&R	1595	(257/775,781,768,769).CCLS.
14	BRS	20	((257/775,781,768,769).CCLS.) and (first and second) with gold with (coat\$3 film)
15	BRS	18	(two second) with gold with (coat\$3 film) same (bond near pad)
16	BRS	4	(two second) with (gold au) with (coat\$3 film) same (bond near pad) not ((two second) with gold with (coat\$3 film) same (bond near pad))
17	BRS	1404	(two second) with (gold au) with (coat\$3 film)
18	BRS	105	(two second) with (gold au) with (coat\$3 film) and pad
19	BRS	305	composite near (gold au)
20	BRS	31	composite near (gold au)near3 (caot\$3 film)
21	BRS	52	composite near (gold au) near3 (coat\$3 film)
22	IS&R	2	("5625734").PN.

	DBs
11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
17	JPO; DERWENT
18	JPO; DERWENT
19	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
20	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
21	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB